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Press Release

Kester to Exhibit K100LD at NEPCON China/EMT China 2007

Itasca, IL — April 13, 2007 — Kester will feature its low-cost Ultrapure K100LD lead-free bar solder alloy in booth 2G30 at the upcoming NEPCON China/EMT China 2007 exhibition and conference, scheduled to take place April 24-27, 2007, in Shanghai, PR China.

K100LD is a patent-pending, low-cost alternative to traditional lead-free alloys. The bar solder offers the lowest copper dissolution of any lead-free bar on the market, even amongst all common alloys, including Sn63, SAC305 and other lead-free options.

K100LD represents an improvement over competitive alloys, including other variations of Tin-Copper-Nickel (SnCuNi). K100LD is a low-cost (silver-free) lead-free alloy primarily containing tin and copper with the inclusion of metallic dopants to control the grain structure and the Copper dissolution rate. K100LD has a slower rate of Copper dissolution than competitive SnCuNi alloys, which minimizes pot maintenance, maintains consistent soldering performance and improves reliability. K100LD has a copper dissolution rate 20 percent slower than the competitive SnCuNi alloy and even Sn63Pb37. K100LD compares favorably to other low-cost, lead-free alloys in terms of wetting and flow characteristics, providing users with optimal soldering performance and minimal defects.

Besides offering the lowest dissolution of copper from boards and components of any lead-free alloy, K100LD offers numerous benefits, including anti-drossing technology, bright, smooth solder joints with no visible shrinkage effects, excellent through-hole penetration and topside fillet with virtually no bridging, and reduced leaching of solder pot materials. Additionally, K100LD is compatible with all types of board and component metallizations, is compatible with other SnCuNi alloys, and its lead level is specified at less than 0.05 percent, ensuring RoHS compliance.

For more information on Kester's full line of products and services including SE-CURE™ and InnovaBond™ products, contact Kester by phone at (+65) 6 449-1133, by fax at (+65) 6 242-9036, or by e-mail at customerservice@kester.com.sg. Kester's Web site may be found at www.kester.com.

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Founded in 1899, Kester is a world-renowned supplier of solder and related materials and services to the electronics assembly, micro-component, and industrial soldering markets. Kester is known for high quality, advanced technology and superior technical support. With headquarters in Itasca, IL, Kester has additional manufacturing

facilities in the United States, Mexico, Canada, Singapore, Germany, Japan, Brazil, Taiwan, Malaysia and China. Its worldwide manufacturing and technical capabilities provide the support required to serve major electronics manufacturing services providers and OEMs.